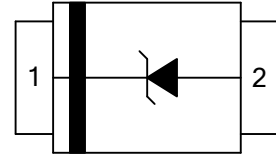


Description

The SFD52AxxL01 of Transient Voltage Suppressors (TVS) are designed to replace multilayer varistors (MLVs) in portable applications such as cell phones, notebook computer, and PDAs. They offer superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs. They are designed to protect sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD), lightning, electrical fast transients (EFT), and cable discharge events (CDE).



Features

- IEC61000-4-2 ESD 30KV Air, 30KV contact compliance
- Protects one I/O line
- Working voltage: 5V,7V
- Low leakage current
- Low operating and clamping voltages
- Solder reflow temperature: Pure Tin-Sn, 260~270°C

Applications

- Cellular handsets & Accessories
- Cordless phones
- Personal digital assistants (PDAs)
- Notebooks & Handhelds
- Portable instrumentation
- Digital cameras
- Peripherals
- MP3 players

Maximum Ratings

Rating	Symbol	Value	Unit
ESD voltage (Contact discharge)	V _{ESD}	±30	kV
ESD voltage (Air discharge)		±30	
Storage & operating temperature range	T _{STG} , T _J	-55~+150	°C

Electrical Characteristics (T_J=25°C)

SFD52A05L01

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V _{RWM}				5.0	V
Reverse breakdown voltage	V _{BR}	I _{BR} =1mA	6.0			V
Reverse leakage current	I _R	V _R =5V			1.0	μA
Clamping voltage (tp=8/20μs)	V _C	I _{PP} =1A			9.8	V
Clamping voltage (tp=8/20μs)	V _C	I _{PP} =18A			25.0	V
Peak pulse current (tp=8/20μs)	I _{PP}				18	A
Off state junction capacitance	C _J	0Vdc,f=1MHz		200		pF

SFD52A07L01

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	V _{RWM}				7.0	V
Reverse breakdown voltage	V _{BR}	I _{BR} =1mA	7.5			V
Reverse leakage current	I _R	V _R =7V			1.0	μA
Clamping voltage (tp=8/20μs)	V _C	I _{PP} =1A			12.0	V
Clamping voltage (tp=8/20μs)	V _C	I _{PP} =16A			25.0	V
Peak pulse current (tp=8/20μs)	I _{PP}				16	A
Off state junction capacitance	C _J	0Vdc,f=1MHz		190		pF

Typical Characteristics Curves

Figure 1. Power Derating Curve

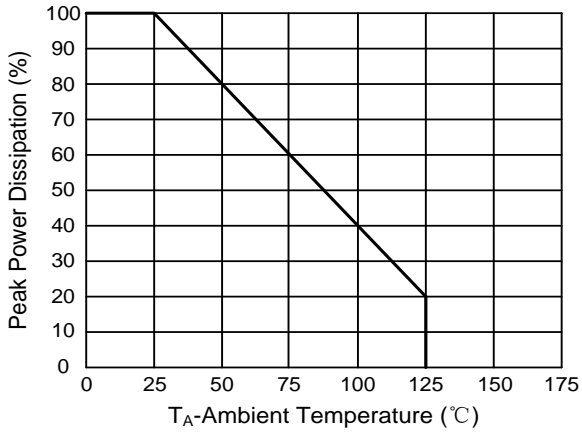


Figure 2. Pulse Waveforms

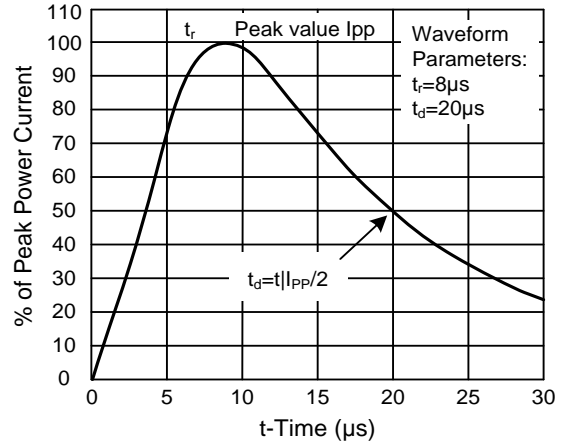
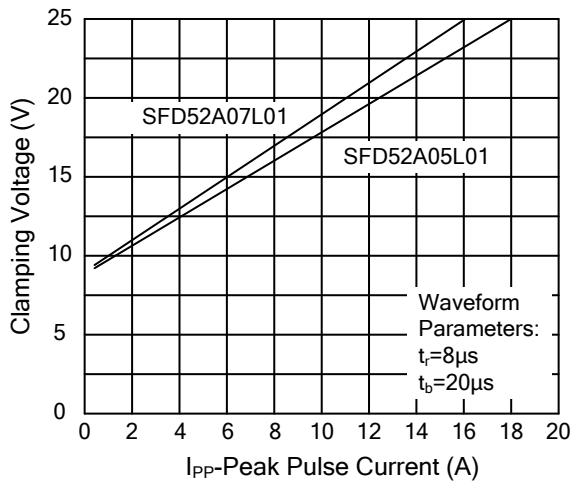
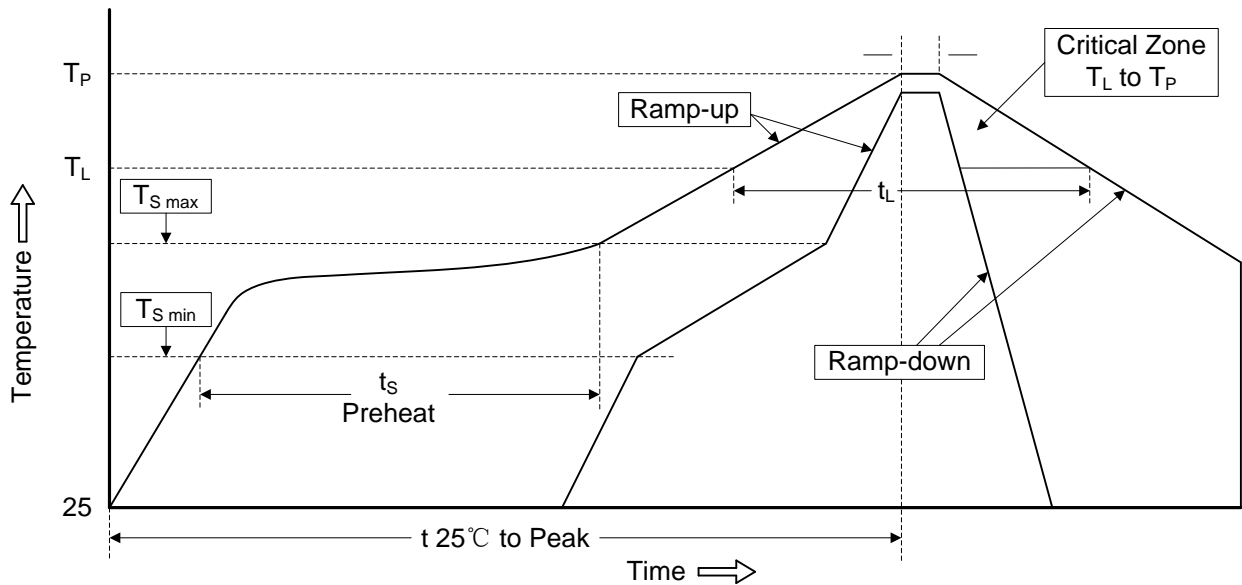


Figure 3. Clamping Voltage vs. Peak Pulse Current



Recommended Soldering Conditions

Reflow Soldering

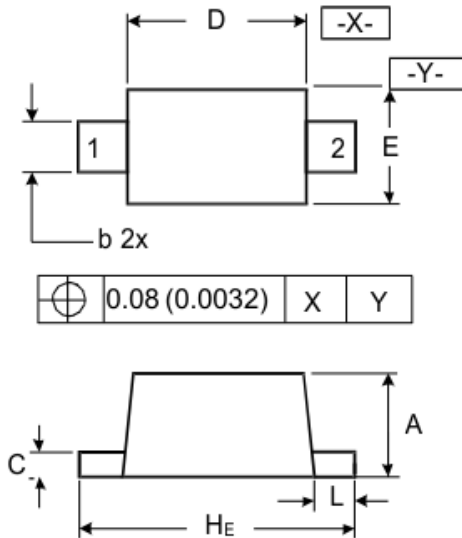


Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat -Temperature Min ($T_{S\ min}$) -Temperature Max ($T_{S\ max}$) -Time (min to max) (t_s)	150°C 200°C 60-180 seconds
$T_{S\ max}$ to T_L -Ramp-up Rate	3°C/second max.
Time maintained above: -Temperature (T_L) -Time (t_L)	217°C 60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Package outline dimensions

SOD-523



DIMENSIONS

SYMBOL	MILLIMETER		INCHES	
	MIN	MAX	MIN	MAX
A	0.50	0.70	0.020	0.028
b	0.25	0.35	0.010	0.014
C	0.07	0.20	0.0028	0.0079
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
HE	1.50	1.70	0.059	0.067
L	0.15	0.25	0.006	0.010

Ordering information

Order code	Package	Base qty	Delivery mode	Marking
UMW SFD52A05L01	SOD-523	3000	Tape and reel	BG
UMW SFD52A07L01	SOD-523	3000	Tape and reel	BH

单击下面可查看定价，库存，交付和生命周期等信息

[>>UMW\(友台半导体\)](#)